

Opto Plus LED Corp.
0.3" Case Mold Type LED Display
OPD-S3010UPG-BW
OPD-S3011UPG-BW

● **FEATURES**

- 0.3 inch (7.62 mm) Digit Height.
- Low current operation.
- Case mold type.
- Black face, White segment.
- RoHS compliant, Pb Free.

● **DESCRIPTION**

The OPD-S3010UPG-BW & OPD-S3011UPG-BW are 0.3 inch (7.62mm) height single 7-segment display.

This device utilizes Pure Green LED chip which are made from InGaN on a transparent GaN.

The display has Black face, White segment.

● **DEVICE**

PART NO Pure Green	DESCRIPTION
OPD-S3010UPG-BW	Common Anode
OPD-S3011UPG-BW	Common Cathode

RoHS Compliance



Pb free.





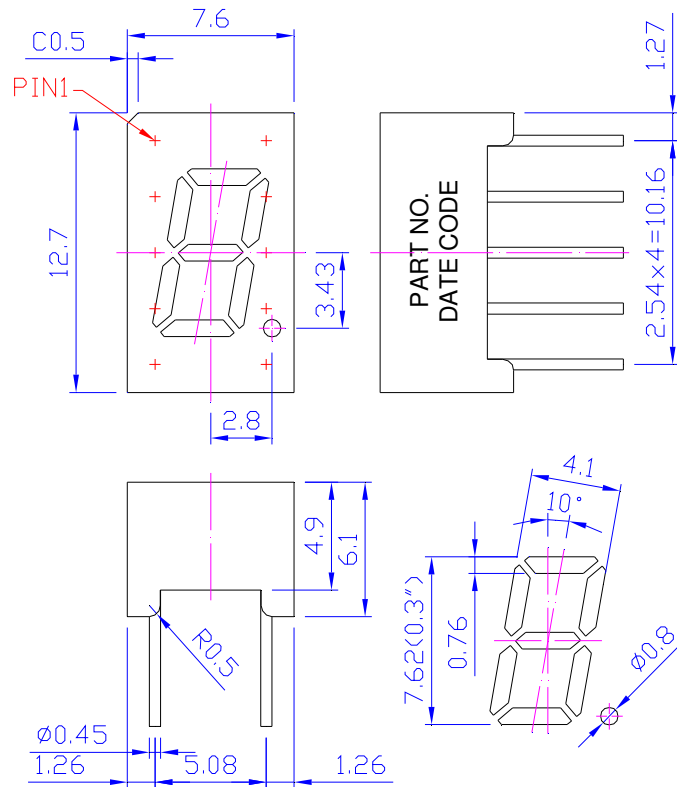
Opto Plus LED Corp.

0.3" Case Mold Type LED Display

OPD-S3010UPG-BW

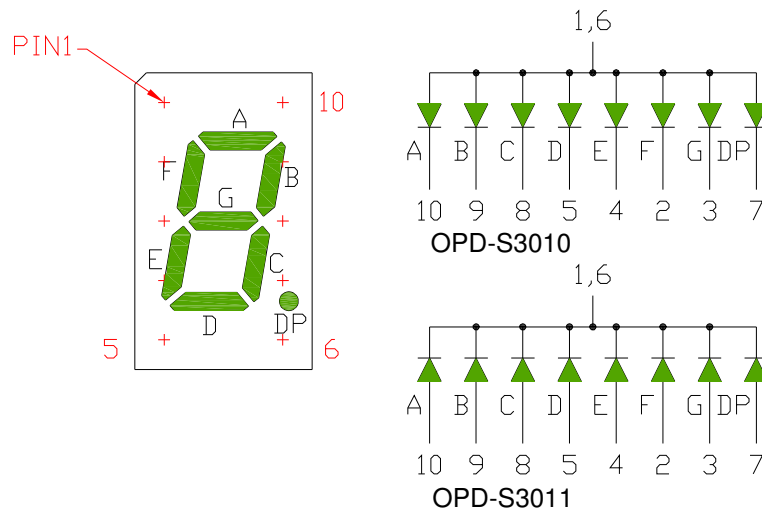
OPD-S3011UPG-BW

MECHANICAL DIMENSIONS



NOTES: Dimension is in millimeters. Tolerance is ± 0.25 mm unless otherwise noted.

TYPICAL INTERNAL EQUIVALENT CIRCUIT





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● **PG: PURE GREEN (InGaN/GaN)**

ABSOLUTE MAXIMUM RATING AT Ta=25°C

Parameter	Symbol	Pure Green	Unit
Power dissipation per dice	P _{AD}	120	mW
Derating liner from 25°C per dice	-	0.3	mA / °C
Continuous forward current per dice	I _{AF}	30	mA
Peak current per dice (duty cycle 1/10, 1kHz)	I _{PF}	100	mA
Reverse voltage per dice	V _R	5	V
Operating temperature	T _{OPR}	-25 to +85	°C
Storage temperature	T _{STG}	-25 to +85	°C

ELECTRICAL - OPTICAL CHARACTERISTICS AT Ta=25°C

Characteristic	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward voltage	V _F	I _F =20mA	-	3.2	4.0	V
Reverse current	I _R	V _R =8V	-	-	10	μA
Dominant wavelength	λ _D	I _F =20mA	-	525	-	nm
Luminous intensity	I _v	I _F =20mA	-	140	-	mcd
Spectral radiation bandwidth	Δλ	I _F =20mA	-	30	-	nm



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● PG: PURE GREEN (InGaN/GaN) CURVE

Typical Electro-optical Characteristic Curves
(25 °C Free Air Temperature Unless Otherwise Specified)

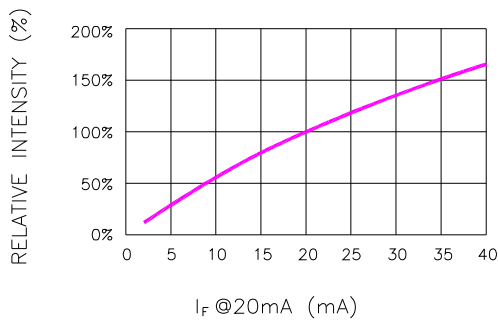


Fig.1 RELATIVE INTENSITY VS. FORWARD CURRENT

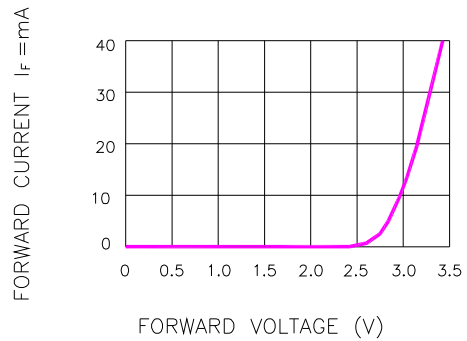


Fig.2 FORWARD CURRENT VS. FORWARD VOLTAGE

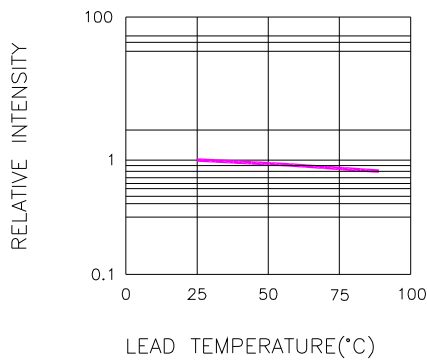


Fig.3 RELATIVE INTENSITY VS. LEAD TEMPERATURE
(PULSED 20 mA; 300us PULSE, 10ms PERIOD)

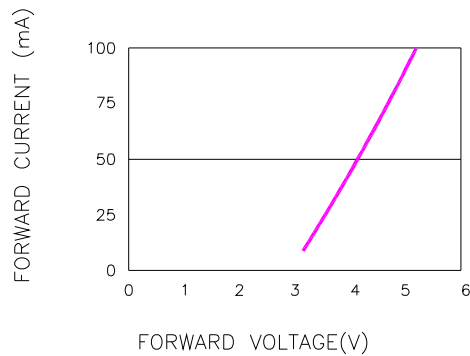


Fig.4 PEAK FORWARD VOLTAGE VS. FORWARD (100us TEST PULSE, 1% DUTY CYCLE)

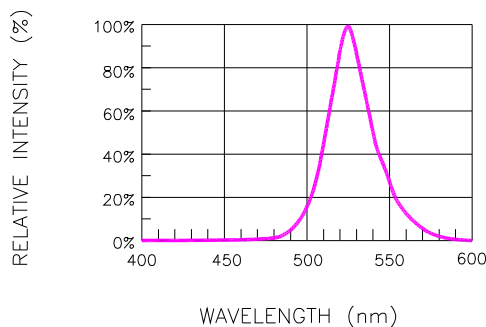


Fig.5 RELATIVE INTENSITY VS. WAVELENGTH

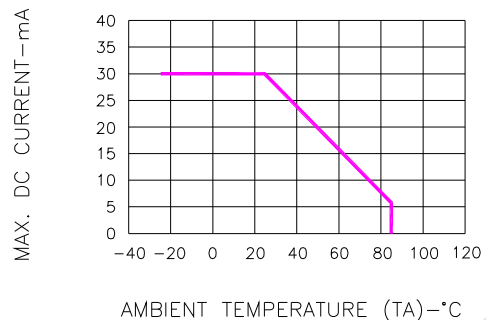
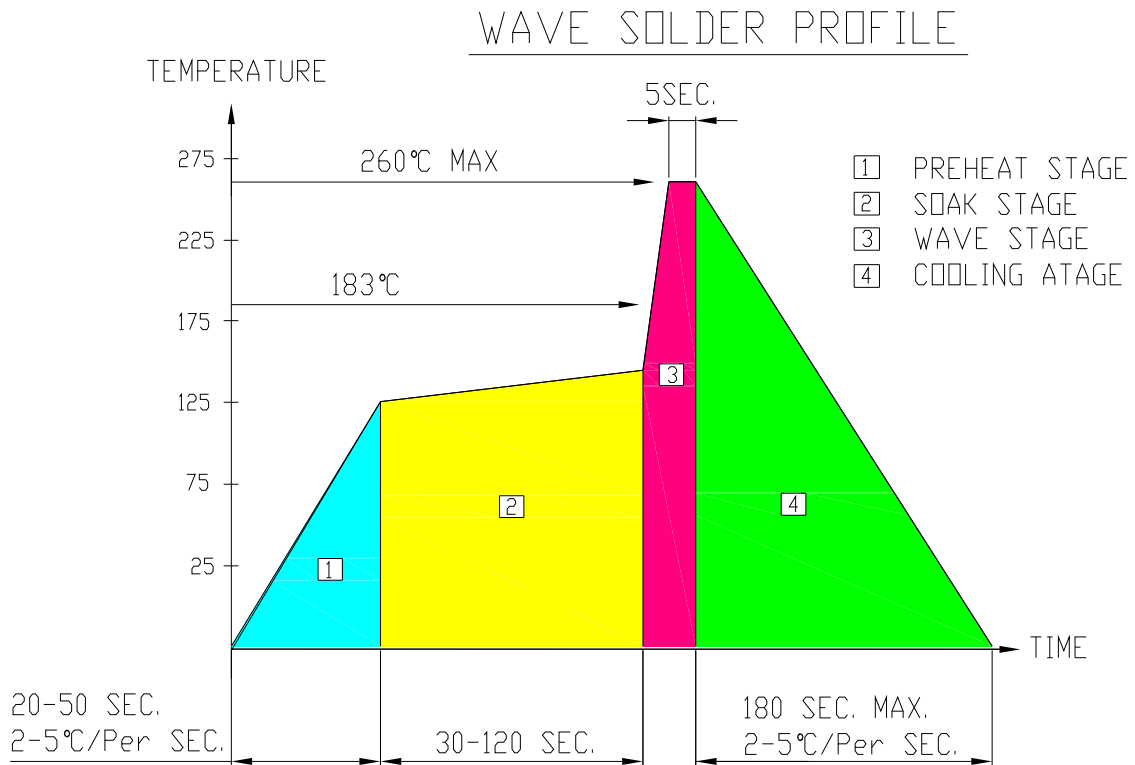


Fig.6 MAX. ALLOWABLE DC CURRENT VS. AMBIENT TEMPERATURE



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● **RECOMMEND SOLDERING PROFILE**



● **SOLDERING IRON**

Basic spec is ≤ 4 sec when 260°C. If temperature is higher, time should be shorter (+10°C → 1 sec). Power dissipation of Iron should be smaller than 15W, and temperature should be controllable. Surface temperature of the device should be under 230°C.

● **REWORK**

Customer must finish rework within ≤ 4 sec under 245°C.